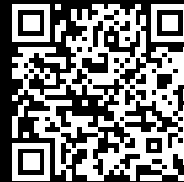


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SK 3311.530 Liquid Cooling Package

State: 07/06/2025 (Source: [rittal.com/sg-en](https://www.rittal.com/sg-en))

ENCLOSURES

POWER DISTRIBUTION

CLIMATE CONTROL

IT INFRASTRUCTURE

SOFTWARE & SERVICES

FRIEDHELM LOH GROUP



SK 3311.530 - Liquid Cooling Package LCP Inline CW, LCP Inline CWG

Bayed climate control designed for siting within a bayed enclosure suite. The hot air is extracted at the rear of the unit, cooled and then expelled forwards to the cold aisle.

Features

Model No.	SK 3311.530
Benefits	<p>Maximum energy efficiency due to EC fan technology and IT-based control</p> <p>Minimal pressure loss at the air end, which in turn minimises the power consumption of the fans</p> <p>Optimum adaptability due to dynamic, continuous control of the cold water volume flow</p> <p>By using high water inlet temperatures, the proportion of indirect free cooling is increased, which in turn reduces operating costs</p> <p>Targeted cooling output due to modular fan units</p> <p>Fan modules configurable as n+1 redundancy</p> <p>Standard 3-phase connection for electrical redundancy</p> <p>With redundant temperature sensor integrated at the air end as standard</p> <p>The separation of cooling and enclosure prevents the ingress of water into the server enclosure</p> <p>A footprint of max. 0.36 m² for all cooling services</p> <p>Improved heat recovery, thanks to high water return temperatures when using LCP CW glycol variants, for example in combination with a heat pump</p> <p>Optimum access for maintenance and servicing from the front and rear</p> <p>Tool-free replacement of the fan modules</p>
Function principle	<p>The hot air is drawn in from the room or hot aisle at the rear of the device and expelled at the front into the cold aisle after cooling.</p> <p>With this product, a raised floor is not necessary.</p>
Material	Sheet steel, spray-finished
Colour	RAL 7035

Features

Options	Direct connection of additional CMC III sensors is supported Racks 2200 mm high
Design	Suite cooling
Monitoring	Monitoring of all system-relevant parameters such as server air intake temperature, server waste air temperature, water inlet/return temperature, water flow, cooling output, fan speed, leakage Direct connection of the unit via SNMP over Ethernet Integration into RiZone
Total cooling output/Number of fan modules	10 kW/1 20 kW/2 30 kW/3
Air throughput (unimpeded air flow)	At 50 Hz: 4,800 m ³ /h At 60 Hz: 4,800 m ³ /h
Number of fan modules in supplied state	1
Dimensions	Width: 300 mm Height: 2,000 mm Depth: 1,200 mm
To fit enclosure type	TS IT
Installation in bayed enclosure suite	Set forward
Rated operating voltage	230 V, 1~, 50 Hz/60 Hz 400 V, 3~, 50 Hz/60 Hz
Max. cooling output	30 kW
Type of electrical connection	Connector
Duty cycle	100 %
Cooling medium	Water
EC fan	Yes
Fans may be exchanged with the system operational	Yes
Temperature control	Linear fan control Two-way control valve

Features

Water connections	DN 40 (G 1½" external thread)
Water inlet temperature	15 °C
Protection category to IEC 60 529	IP 20
Options	Direct connection of additional CMC III sensors is supported Racks 2200 mm high
Packs of	1 pc(s).
ETIM 9	EC002515
ETIM 8	EC002515
ECLASS 8.0	27180712

Approvals

Explanations	Declaration of conformity
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